



74AHC595

8-BIT SHIFT REGISTER WITH 8-BIT OUTPUT REGISTER

Description

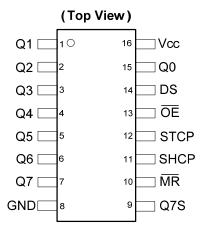
The 74AHC595 is an advanced high speed CMOS device.

An eight bit shift register accepts data from the serial input (DS) on each positive transition of the shift register clock (STCP). When asserted low the reset function (\overline{MR}) sets all shift register values to zero and is independent of all clocks.

Data from the input serial shift register is placed in the output register with a rising pulse on the storages resister clock (SHCP). With the output enable (\overline{OE}) asserted low the 3-state outputs Q0-Q7 become active and present.

All registers capture data on rising edge and change output on the falling edge. If both clocks are connected together, the input shift register is always one clock cycle ahead of the output register.

Pin Assignments



SO-16 / TSSOP-16

Features

- Wide Supply Voltage Range from 2.0 V to 5.5V
- Sinks or sources 8mA at V_{CC} = 4.5V
- CMOS low power consumption
- Schmitt Trigger Action at All Inputs
- Inputs Accept up to 5.5V
- ESD Protection Tested per JESD 22
 - Exceeds 200-V Machine Model (A115-A)
 - Exceeds 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Latch-Up Exceeds 250mA per JESD 78, Class II
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Applications

- General Purpose Logic
- Serial to Parallel Data conversion
- Capture and hold data for extended periods of time
- Allow simple serial bit streams from a microcontroller to control as many peripheral lines as needed
- · Wide array of products such as:
 - Computer peripherals
 - Appliances
 - Industrial control

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

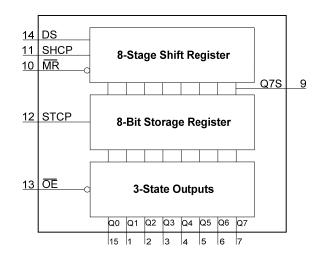
Click here for ordering information, located at the end of datasheet



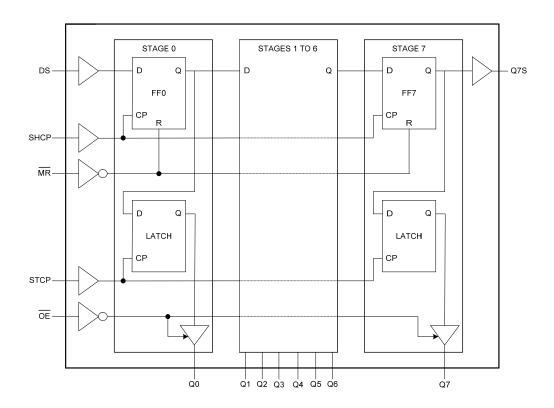
Pin Descriptions

Pin Number	Pin Name	Description
1	Q1	Parallel Data Output 1
2	Q2	Parallel Data Output 2
3	Q3	Parallel Data Output 3
4	Q4	Parallel Data Output 4
5	Q5	Parallel Data Output 5
6	Q6	Parallel Data Output 6
7	Q7	Parallel Data Output 7
8	GND	Ground
9	Q7S	Serial Data Output
10	MR	Master Reset Input
11	SHCP	Shift Register Clock Input
12	STCP	Storage Register Clock Input
13	ŌE	Output Enable Input
14	DS	Serial Data Input
15	Q0	Parallel Data Output 0
16	Vcc	Supply Voltage

Functional Diagram



Logic Diagram

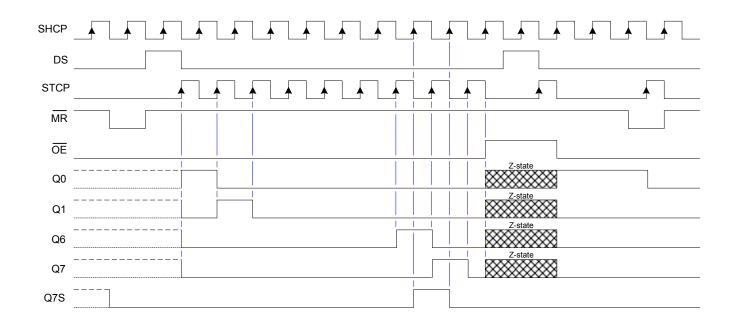




Functional Description and Timing Diagram

	Contr	rol		Input	Output		Fination
SHCP	STCP	OE	MR	DS	Q7S	Qn	Function
Х	Х	L	L	-	L	NC	Low-level asserted on MR clears shift register. Storage register is unchanged
Х	1	L	L	_	L	L	Empty shift register transferred to storage register
Х	Х	Н	L	_	L	Z	Shift register remains clear;: All Q ouputs in Z state.
↑	x	L	Н	-	Q6S	NC	HIGH is shifted into first stage of Shift Register Contents of each register shifted to next register The content of Q6S has been shifted to Q7S and now appears on device pin Q7S
Х	1	L	Н	-	NC	QnS	Contents of shift register copied to storage register. With output now in active state the storage resister contents appear on Q outputs.
↑	↑	L	Н	_	Q6S	QnS	

H=HIGH voltage state L=LOW voltage state ↑=LOW to HIGH transition X= don't care – high or low (not floating) NC= No change Z= high-impedance state





Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to 7.0	V
VI	Input Voltage Range	-0.5 to 7.0	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current V _I < -0.5V	-20	mA
I _{OK}	Output Clamp Current V _O <-0.5V	-20	mA
lok	Output Clamp Current V _O > V _{CC} + 0.5V	25	mA
I _O	Continuous output current	+/- 25	mA
Icc	Continuous current through Vcc or GND	75	mA
I _{GND}	Continuous current through Vcc or GND	-75	mA
TJ	Operating Junction Temperature	-40 to 150	°C
T _{STG}	Storage Temperature	-65 to 150	°C
Ртот	Total Power Dissipation	500	mW

Note:

Recommended Operating Conditions (Note 5) (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage	-	2.0	5.5	V
Vı	Input Voltage	-	0	5.5	V
Vo	Output Voltage	Active Mode	0	V _{CC}	V
Δt/ΔV	Input transition Rise or Fall Rate	V _{CC} = 3.0V to 3.6V	-	100	ns/V
ΔυΔν	Imput transition Rise of Fall Rate	V _{CC} = 4.5V to 5.5V	=	20	115/ V
T _A	Operating Free-Air Temperature	-	-40	+125	°C

Note:

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	Vcc	Т	_A = +25°	,C	$T_A = -40^{\circ}$	C to +85°C	$T_A = -40^{\circ}C$	to +125°C	Unit
Syllibol	i arameter	rest conditions VCC		Min	Тур	Max	Min	Max	Min	Max	Oilit
	Link lavel land	=	2.0V	1.5	_	-	1.5	-	1.5	-	
V_{IH}	High-level Input Voltage	=	3.0V	2.1	_	-	2.1	-	2.1	-	V
	Voltage	=	5.5V	3.85	_	-	3.85	-	3.85	-	
	l avv laval innut	=	2.0V	-	_	0.5	-	0.5	-	0.5	
V_{IL}	Low-level input voltage	=	3.0V	-	_	0.9	-	0.9	-	0.9	V
	voltage	_	5.5V	-	-	1.65	_	1.65	-	1.65	
		I _{OH} = -50μA	2.0V	1.9	2.0	-	1.9	-	1.9	-	
	l	I _{OH} = -50μA	3.0V	2.9	3.0	_	2.9	_	2.9	_	V
VoH	High Level Output Voltage	I _{OH} = -50μA	4.5V	4.4	4.5	-	4.4	-	4.4	-	
	Output Voltage	I _{OH} = -4mA	3.0V	2.58	_	_	2.48	_	2.40	_	
		I _{OH} = -8mA	4.5V	3.94	_	-	3.80	-	3.70	=	1
		I _{OL} = 50μA	2.0V	-	0	0.1	-	0.1	-	0.1	
	l	I _{OL} = 50μA	3.0V	-	0	0.1	_	0.1	-	0.1	
V_{OL}	Low-level Output Voltage	I _{OL} = 50μA	4.5V	-	0	0.1	_	0.1	-	0.1	
	Output voltage	I _{OL} = 4mA	3.0V	-	_	0.36	-	0.44	-	0.55	1
		I _{OL} = 8mA	4.5V	-	=	0.36	_	0.44	-	0.55	
lı	Input Current	V_I = GND to 5.5V	5.5V	-	0.1	±0.1	_	±1	-	±2	μΑ
la-	OFF-state	$V_I = V_{IH} \text{ or } V_{IL};$	5.5V		_	±0.25	_	±2.5		±10	μA
102	output current	$V_O = V_{CC}$ or GND	3.50	_	_	10.23	_	12.5	_	110	μΛ
Icc	Supply Current	$V_I = GND \text{ or } V_{CC} I_O = 0$	5.5V	_	=	4.0	=	40	-	80	μA
Ci	Input Capacitance	V _i = V _{CC} or GND	5.5V	_	4	10	=	10	-	10	pF

^{4.} Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

^{5.} Unused inputs should be held at V_{CC} or Ground.



Switching Characteristics

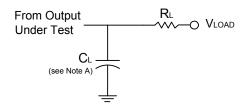
Symbol /	Pins	Test Conditions	V	Т	A = +25°	С	-40°C to	o +85°C	-40°C to	+125°C	Unit																		
Parameter	Pins	rest Conditions	V _{CC}	Min	Тур	Max	Min	Max	Min	Max	Unit																		
f _{MAX}			3.0V to 3.6V	80	125	_	60	-	40	_																			
Maximum Frequency	SHCP or STCP	Figure 2	4.5V to 5.5V	130	70	-	110	-	90	-	MHz																		
	SHCP	Figure 2	3.0V to 3.6V	5.0	_	_	5.0	-	5.0	_																			
	HIGH or LOW	Figure 2	4.5V to 5.5V	5.0	_	_	5.0	-	5.0	_																			
t _W	STCP	Figure 2	3.0V to 3.6V	5.0	_	_	5.0	-	5.0	_	ns																		
Pulse Width	HIGH or LOW	rigure 2	4.5V to 5.5V	5.0	_	-	5.0	-	5.0	_	115																		
	MR LOW	Figure 2	3.0V to 3.6V	5.0	=	=	5.0	=	5.0	_																			
	WIR LOW	Figure 2	4.5V to 5.5V	5.0	_	_	5.0	-	5.0	_																			
	DS to SHCP	Figure 2	3.0V to 3.6V	3.5	_	_	3.5	-	3.5	_	20																		
tsu	D3 10 3HCF	Figure 2	4.5V to 5.5V	3.0	_	_	3.0	-	3.0	_	ns																		
Set-up Time	SHCP to STCP	Figure 2	3.0V to 3.6V	8.5	_	_	8.5	-	8.5	_	ns																		
	3HCF 10 3TCF	Figure 2	4.5V to 5.5V	5.0	-	-	5.0	-	5.0	_	115																		
t _H	DS to SHCP	Figure 2	3.0V to 3.6V	1.5	_	-	1.5	-	1.5	_	ns																		
Hold Time	D3 10 3HCF	Figure 2	4.5V to 5.5V	2.0	_	-	2.0	-	2.0	_	115																		
t _{REC}	me MR to SHCP	Time MR to SHCP	Figure 2	3.0V to 3.6V	3.0	_	-	3.0	-	3.0	_	ns																	
Recovery Time			MR to SHCP	MR to SHCP	MR to SHCP	MR to SHCP	MR to SHCP	WIR IO SHUP	rigure 2	4.5V to 5.5V	2.5	_	-	2.5	-	2.5	_	115											
		Figure 2	3.0V to 3.6V	-	5.7	13.0	1.0	15.0	1.0	16.5																			
	SHCP to Q7S	$C_L = 15pF$	4.5V to 5.5V	-	4.0	8.2	1.0	9.4	1.0	10.5	ns																		
	SHCP 10 Q/S	3HCF 10 Q/3	3HCF 10 Q/3	3HCF 10 Q/3	3HCF 10 Q/3	3HCP 10 Q/3	3HCP 10 Q/3	3HCP 10 Q/3	3HCP 10 Q/3	SHCP to Q75	SHCP to Q75	SHCP to Q75	SHCP to Q75	3HCP 10 Q/3	3HCF 10 Q/3	3HCF 10 Q/3	311CF 10 Q73	311CF 10 Q73	311CF 10 Q73	Figure 2	3.0V to 3.6V	-	7.7	16.5	1.0	18.5	1.0	20.1	115
		$C_L = 50pF$	4.5V to 5.5V	-	5.4	10.0	1.0	11.4	1.0	12.5																			
		Figure 2	3.0V to 3.6V	-	5.9	11.9	1.0	13.5	1.0	15.0																			
t _{PD}	STCP to Qn	$C_L = 15pF$	4.5V to 5.5V	_	4.2	7.4	1.0	8.5	1.0	10.5	no																		
Propagation Delay	31CF (0 QII	Figure 2	3.0V to 3.6V	_	7.7	15.4	1.0	17.0	1.0	18.5	ns																		
Bolay		$C_L = 50pF$	4.5V to 5.5V	_	5.5	9.0	1.0	10.5	1.0	11.5																			
		Figure 2	3.0V to 3.6V	-	5.9	12.8	1.0	13.7	1.0	15.0																			
	MR to Q7S	$C_L = 15pF$	4.5 V to 5.5V	-	4.4	8.0	1.0	9.1	1.0	10.5	ne																		
	MR to Q7S	Figure 2	3.0V to 3.6V	_	7.4	16.3	1.0	17.2	1.0	18.7	ns																		
		$C_L = 50pF$	4.5V to 5.5V	_	5.6	10.0	1.0	11.1	1.0	12.0																			
		Figure 2	3.0V to 3.6V	-	5.6	11.5	1.0	13.5	1.0	15.0																			
t _{EN}	== +- 0-	$C_L = 15pF$	4.5V to 5.5V	_	4.0	8.6	1.0	10.0	1.0	10.5	ns																		
Enable Time	ime OE to Qn	Figure 2	3.0V to 3.6V	_	7.4	15.0	1.0	17.0	1.0	18.5	115																		
		$C_L = 50pF$	4.5V to 5.5V	_	5.3	10.6	1.0	12.0	1.0	13.0																			
		Figure 2	3.0V to 3.6V	I	5.4	11.0	1.0	13.0	1.0	14.5																			
t _{DIS}	OE to On	$C_L = 15pF$	4.5V to 5.5V	-	3.8	8.0	1.0	9.5	1.0	10.5																			
Disable Time	OE to Qn	Figure 2	3.0V to 3.6V	-	8.7	15.7	1.0	16.2	1.0	17.5	ns																		
		$C_L = 50pF$	4.5V to 5.5V	_	5.8	10.3	1.0	11.0	1.0	12.0																			

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V _{CC} = 5V Typ	Unit
$C_{\sf pd}$	Power dissipation capacitance	f = 1 MHz all outputs switching-no load	42	pF

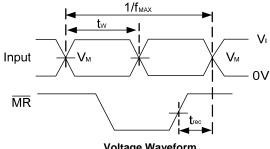


Parameter Measurement Information

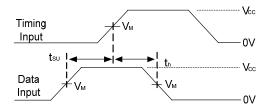


TEST	Vload
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	Vcc
t _{PHZ} /t _{PZH}	GND

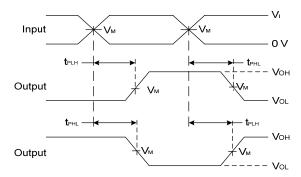
Voc	Inp	outs	V	C.	
Vcc	VI	t _r /t _f	V _M	CL	
3.3V -3.6V	Vcc	3ns	V _{CC} /2	15pF, 50pF	
4.5V to 5.5V	V _{CC}	3ns	V _{CC} /2	15pF, 50pF	



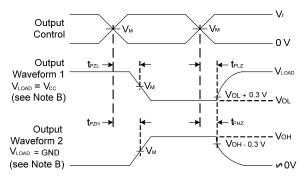
Voltage Waveform Pulse Duration and Recovery Time



Voltage Waveform Set-up and Hold Times



Voltage Waveform
Propagation Delay Times
Inverting and Non Inverting Outputs



Voltage Waveform Enable and Disable Times

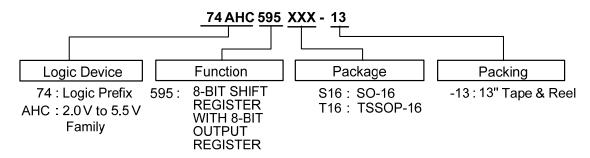
Notes: A .Includes test lead and test apparatus capacitance.

- B. Output Waveform 1 depends on the internal Q_N node being low and behaves in this manner based on OE pin. Output Waveform 2 depends on the internal Q_N node being high and behaves in this manner based on OE pin.
- C. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- D. Inputs are measured separately one transition per measurement
- E. t_{PLH} and t_{PHL} are the same as $t_{\text{PD.}}$

Figure 2. Load Circuit and Voltage Waveforms



Ordering Information

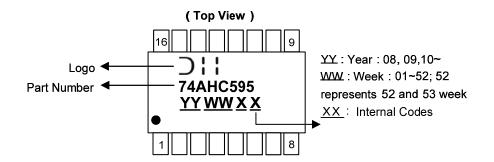


Part Number	Package Code Packaging		7" Tape and	
Part Number	Fackage Code	rackaging	Quantity	Part Number Suffix
74AHC595S16-13	S16	SO-16	2500/Tape & Reel	-13
74AHC595T16-13	T16	TSSOP-16	2500/Tape & Reel	-13

Note: 6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf

Marking Information

(1) SO-16, TSSOP16



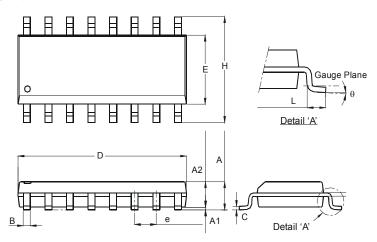
Part Number	Package
74AHC595S16	SO-16
74AHC595T16	TSSOP-16



Package Outline Dimensions (All dimensions in mm.)

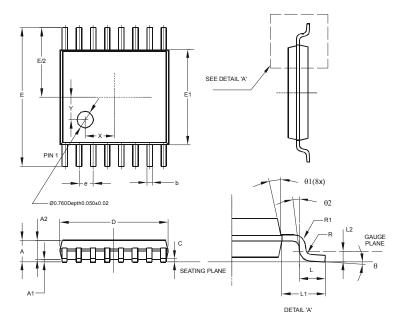
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

Package Type: SO-16



SO-16						
Dim	Min	Max				
Α	1.40	1.75				
A1	0.10	0.25				
A2	1.30	1.50				
В	0.33	0.51				
O	0.19	0.25				
D	9.80	10.00				
Е	3.80	4.00				
е	1.27	Тур				
H	5.80	6.20				
L	0.38	1.27				
Θ	0°	8°				
All D	All Dimensions in mm					

Package Type: TSSOP-16



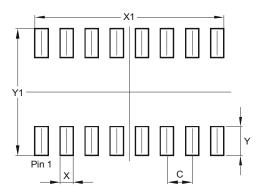
TSSOP-16				
Dim	Min	Max	Тур	
Α	-	1.08	-	
A1	0.05	0.15	-	
A2	0.80	0.93	-	
b	0.19	0.30	-	
C	0.09	0.20	1	
D	4.90	5.10	1	
Е	6.40 BSC			
E1	4.30	4.50	-	
е	0.65 BSC			
L	0.45	0.75	-	
L1	1.00 REF			
L2	0.25 BSC			
R	0.09	ı	1	
R1	0.09	ı	ı	
X	-	ı	1.350	
Υ	-	ı	1.050	
Θ	0°	8°	ı	
Θ1	5°	15°	-	
Θ2	0°	-	-	
All Dimensions in mm				



Suggested Pad Layout

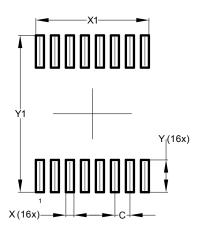
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

Package Type: SO-16



Dimensions	Value (in mm)	
С	1.270	
Х	0.670	
X1	9.560	
Y	1.450	
Y1	6.400	

Package Type: TSSOP-16



Dimensions	Value (in mm)	
С	0.650	
Х	0.350	
X1	4.900	
Υ	1.400	
Y1	6 800	



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